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Assistant Commissioner for Patents
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Sept 18, 2002

Tam Styer

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ev PATENT
Attorney Docket No.: 0000265

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor: Carley)
Serial No.: 09/583,386) Examiner: Erik Kielin
Filing Date: May 30, 2000) Art Unit: 2813
Entitled: MANUFACTURING OF MEMS STRUCTURE IN SEALED CAVITY
USING DRY-RELEASE MEMS DEVICE ENCAPSULATION

RESPONSE AND AMENDMENT

September 18, 2002

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

This communication is being filed in response to the office action dated June 19, 2002 in the above-referenced U.S. patent application.

The Applicant requests the entry of the following amendments:

In the Claims:

- Please re-write Claim 1 as follows:

1. A method of fabricating a microstructure in a sealed cavity comprising the steps of:
providing a substrate;
forming a microstructure composed of a structural material on said substrate, said microstructure being secured to said substrate by a first layer of sacrificial material;
forming a second layer of sacrificial material on said microstructure;

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